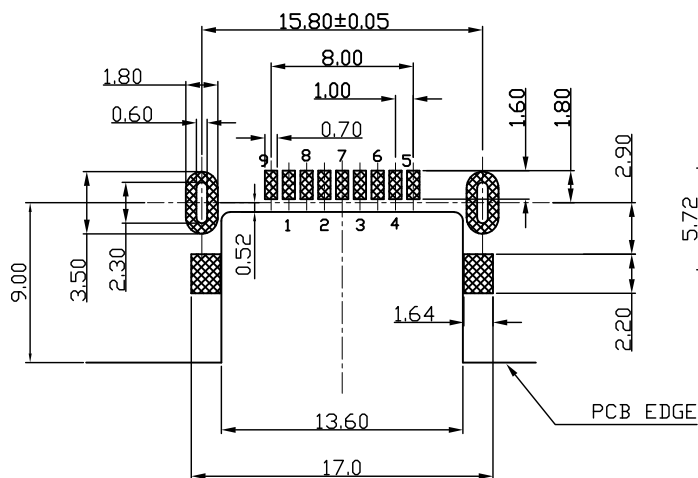
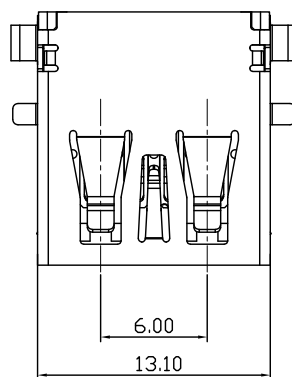
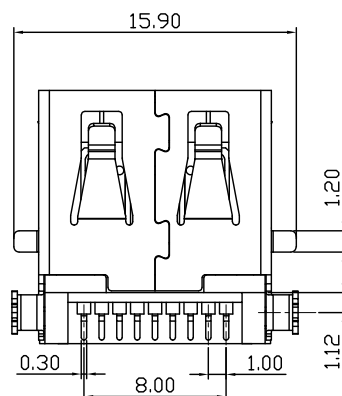
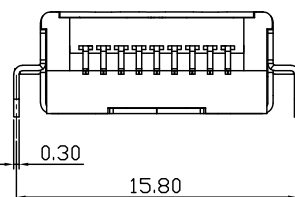
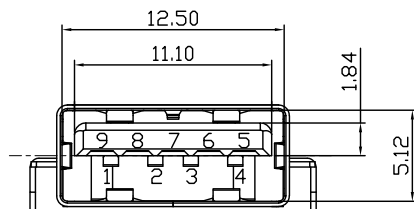
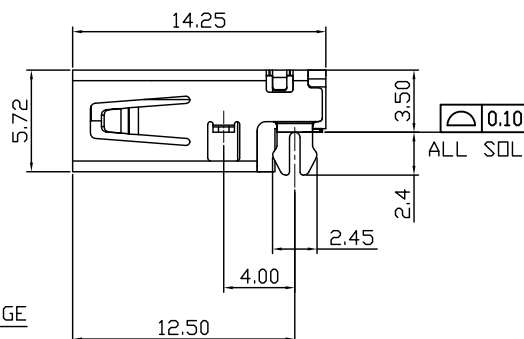




TOLERANCE: ±0.05,
RECOMMENDED PCB LAYOUT
(TOP VIEW)



NOTES:

1.MATERIAL:

- 1.1 HOUSING: HIGH TEMPERATURE THERAL PLASTIC.
- 1.2 SPRING CONTACT: COPPER ALLOY.
- 1.3 FLAT CONTACT;COPPER ALLOY
- 1.4 SHELL :COPPER ALLOY.

2.FINISH:

- 2.1 CONTACT: (SEE P/N.),[50μ"] MIN. NICKEL UNDERPLATING OVER ALL.
- 2.2 SHELL: [50μ"] MIN.SOLDERABILITY NICKEL UNDERPLATING OVER ALL.

PIN NO.	PIN 1	PIN 2	PIN 3	PIN 4
SLGNAL NAME	V BUS	D-	D+	GND
REMARK	USB 2.0 CONTACT PINS			

PIN NO.	PIN 5	PIN 6	PIN 7	PIN 8	PIN 9
SLGNAL NAME	STDA_SSRX-	STDA_SSRX+	GND_DRAIN	STDA_SSTX-	STDA_SSTX+
REMARK	USB 3.0 CONTACT PINS				



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: USB 3.0 AF 沉板 鱼叉脚 无卷边
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC147-USBA09-350
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.
			DRAW NO: HYC-2412071318
			SHEET NO. 1 OF 1